# DISCRETE SEMICONDUCTORS

# DATA SHEET

# **BYV29 series**Rectifier diodes ultrafast

**Product specification** 

September 1998



NXP Semiconductors Product specification

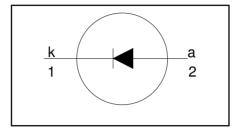
# Rectifier diodes ultrafast

BYV29 series

# **FEATURES**

- · Low forward volt drop
- · Fast switching
- · Soft recovery characteristic
- · High thermal cycling performance
- · Low thermal resistance

# **SYMBOL**



# **QUICK REFERENCE DATA**

$$V_R = 300 \text{ V} / 400 \text{ V} / 500 \text{ V}$$
  $V_F \le 1.03 \text{ V}$   $I_{F(AV)} = 9 \text{ A}$   $t_{rr} \le 60 \text{ ns}$ 

# **GENERAL DESCRIPTION**

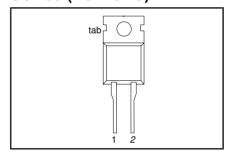
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYV29 series is supplied in the conventional leaded SOD59 (TO220AC) package.

## **PINNING**

PIN	DESCRIPTION		
1	cathode		
2	anode		
tab	cathode		
	anode		

# SOD59 (TO220AC)



# **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
V <sub>RRM</sub>	Peak repetitive reverse voltage	BYV29	-	<b>-300</b>	<b>-400</b> 400	<b>-500</b> 500	V
$V_{RWM}$	Crest working reverse voltage Continuous reverse voltage		-	300 300	400 400	500 500	V
$I_{F(AV)}$	Average forward current <sup>1</sup>	square wave; $\delta = 0.5$ ; $T_{mb} \le 123 ^{\circ}\text{C}$	-		9		Α
I <sub>FRM</sub>	Repetitive peak forward current	$t = 25 \mu s; δ = 0.5;$ $T_{mb} \le 123 °C$	-		18		Α
I <sub>FSM</sub>	Non-repetitive peak forward current.	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-		100 110		A A
T <sub>stg</sub>	Storage temperature Operating junction temperature	$V_{RRM(max)}$	-40 -		150 150		°C

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub>	Thermal resistance junction to mounting base		-	-	2.5	K/W
R <sub>th j-a</sub>	Thermal resistance junction to ambient	in free air.	-	60	1	K/W

<sup>1</sup> Neglecting switching and reverse current losses.

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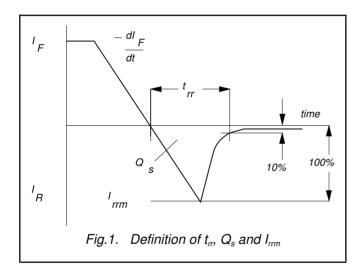
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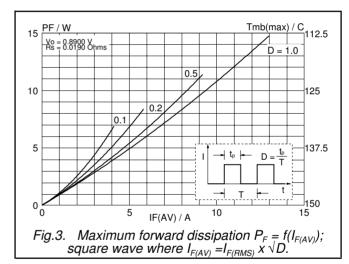
BYV29 series

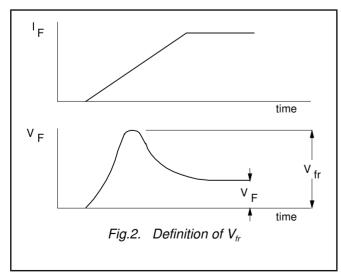
# **ELECTRICAL CHARACTERISTICS**

T<sub>i</sub> = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	$I_F = 8 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.90	1.03	<b>V</b>
	_	$I_F = 8 \text{ A}$	-	1.05	1.25	V
		$I_{\rm F} = 20 \text{ A}$	-	1.20	1.40	V
l <sub>R</sub>	Reverse current	$V_R = V_{RRM}$	-	2.0	50	μΑ
		$V_{R} = V_{RRM}^{(1)}$ ; $T_{j} = 100 ^{\circ}$ C $I_{F} = 2 ^{\circ}$ A to $V_{R} \ge 30 ^{\circ}$ V;	-	0.1	0.35	mΑ
$Q_{\rm s}$	Reverse recovery charge	$I_F = 2 \text{ Å to } V_B \ge 30 \text{ V};$	-	40	60	nC
		$dI_{E}/dt = 20 A/\mu s$				
l t <sub>rr</sub>	Reverse recovery time	$I_F = 1 \text{ A to } V_B \ge 30 \text{ V};$	-	50	60	ns
	,	$dI_F/dt = 100 A/\mu s$				
l I <sub>rrm</sub>	Peak reverse recovery current	$I_{\rm F} = 10 \text{ A to V}_{\rm B} \ge 30 \text{ V};$	-	4.0	5.5	Α
	<b>1</b>	$I_F = 10 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 50 \text{ A/}\mu\text{s}; T_i = 100^{\circ}\text{C}$				
$V_{fr}$	Forward recovery voltage	$I_{\rm F} = 10 \text{ A}$ ; $dI_{\rm F}/dt = 10 \text{ A/}\mu\text{s}$	-	2.5	-	V







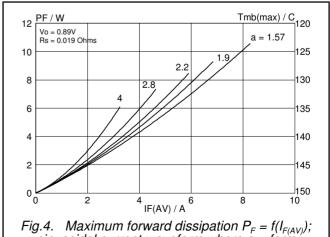
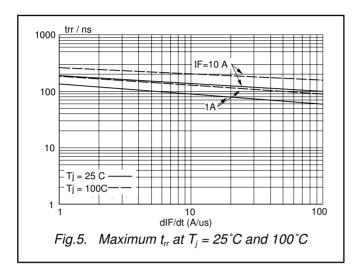


Fig.4. Maximum forward dissipation  $P_F = f(I_{F(AV)})$ ; sinusoidal current waveform where a = form factor =  $I_{F(RMS)} / I_{F(AV)}$ .

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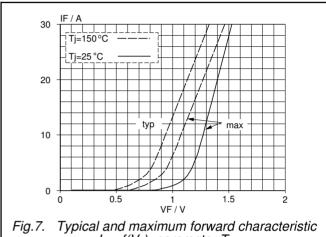
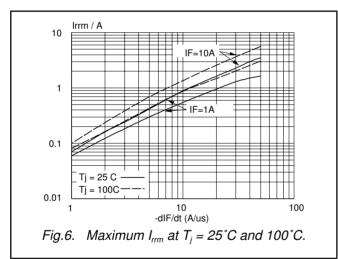
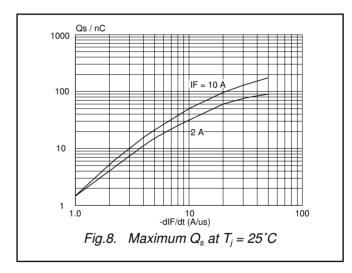
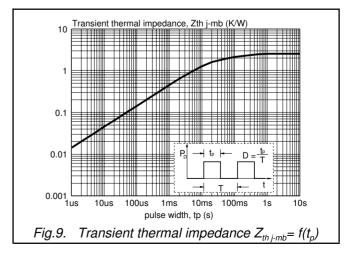


Fig.7. Typical and maximum forward characteristic  $I_F = f(V_F)$ ; parameter  $T_j$ 





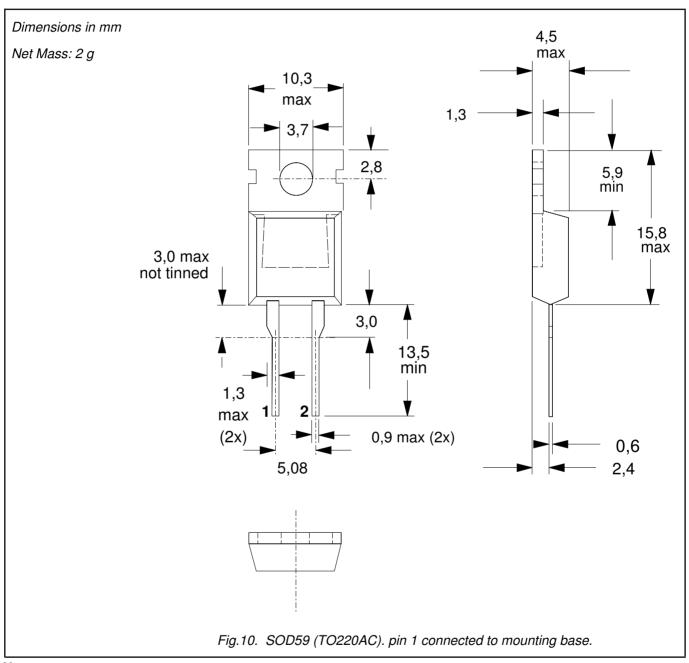


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# **MECHANICAL DATA**



- Refer to mounting instructions for TO220 envelopes.
   Epoxy meets UL94 V0 at 1/8".

# Legal information

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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